



1732

862.C2261

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
: Examiner: Not Yet Assigned
TAKASHI ARAI)
: Group Art Unit: 1732
Application No.: 09/877,092)
: Filed: June 11, 2001)
: For: FOAM MOLDING METHOD AND)
: APPARATUS : September 13, 2001

Commissioner for Patents
Washington, D.C. 20231

PRELIMINARY AMENDMENT

RECEIVED
SEP 18 2001
TC 1700

Sir:

Prior to examining the subject application on the merits, please amend this application as follows and consider the following remarks.

IN THE SPECIFICATION:

Please replace a paragraph beginning at page 9, line 13 and ending at page 9, line 19 with the following paragraph. A marked-up copy of this paragraph showing the changes thereto is attached.

--If a molded product made of a resin material is to be used as a mount member, consideration should be given to a reduction in weight. As a technique of reducing the weight of a resin molded member, a molding method of foaming a resin material is disclosed in USP ^{264/28}4360484, USP ^{521/29}4473665 and Japanese Patent Laid-Open No. 8-300392.--